FIT Hon Teng Limited 鴻騰六零八八精密科技股份有限公司 3Q22 Results Announcement

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Agenda

3Q22 Financial Overview

Guidance Update

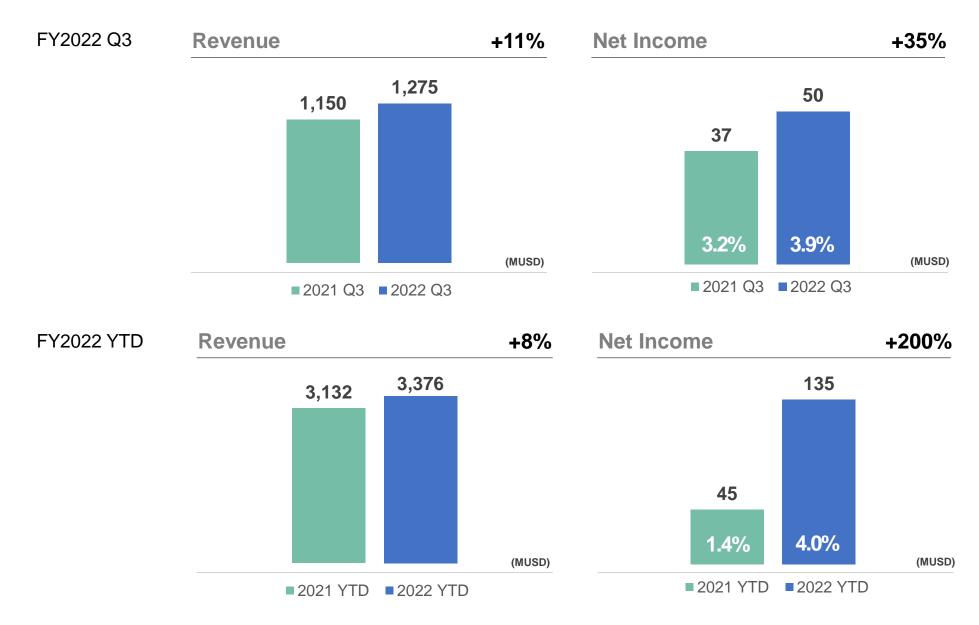
Strategy Update

News Update

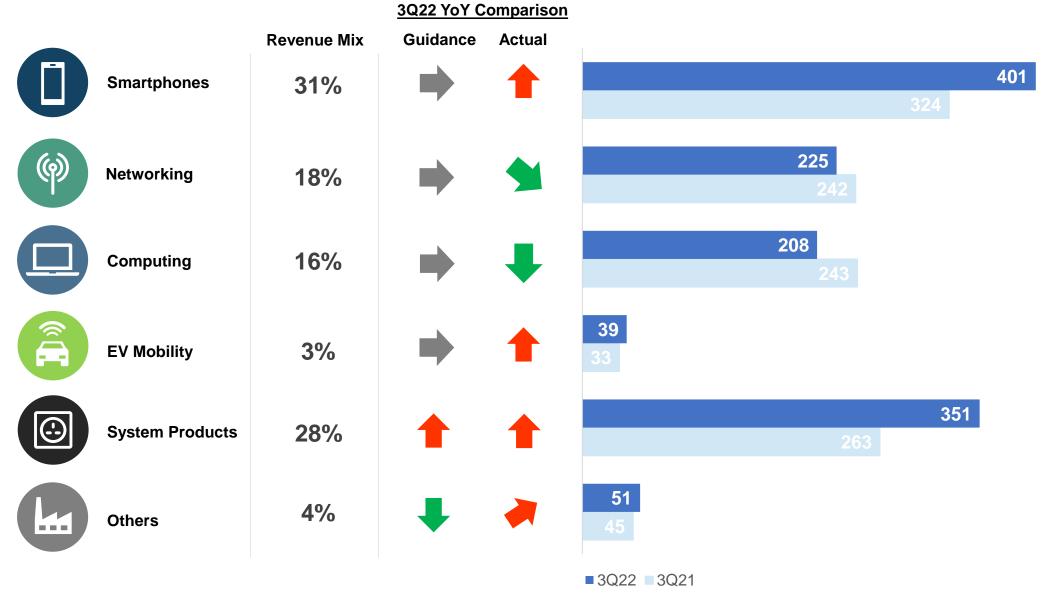
Q&A Section



3Q22 Financial Highlight

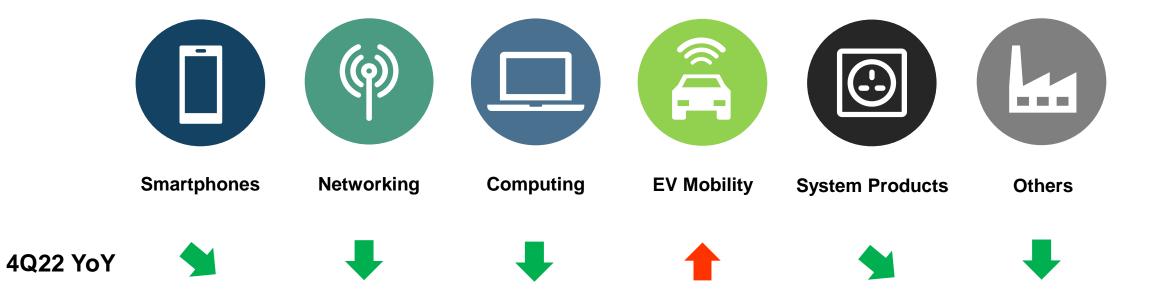


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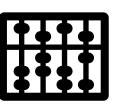




4Q22 Guidance



Full Year Guidance Updates







Revenue

Gross Margin



YoY







Previous
Guidance in
March 2022







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Smartphones





Computing



Mobility



System Products



Others



Previous Guidance in March 2022

YoY





Communications Infrastructure



Computer & Consumer Electronics



EV Mobility, Industry & Medical



Smart Accessories



Industry & Medical





EV Mobility

Growth in E-Bike battery connector & auto connectivity for Tier 1



New Generation 5G AIoT

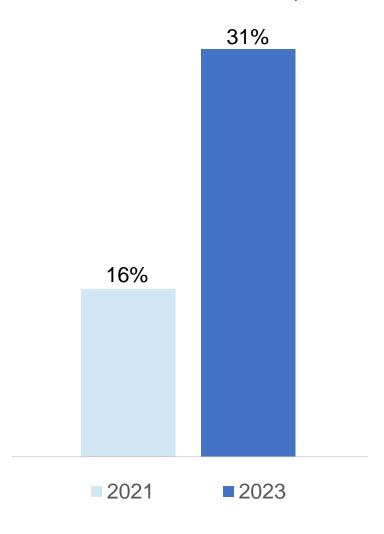
Higher margin product continuously accelerating overall gross margin ratio



Audio

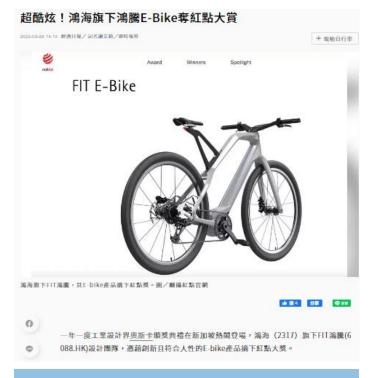
Continuous growth in system products Micro speaker component production

Revenue Mix Forecast Update





Recent Announcements



2022-10-18 12:05

鴻騰EV產品展實力 三大面向延伸六大系列產品



香港2022年10月18日/美通社/--鴻海科技日Hon Hai Tech Day (HHTD22)在今日(10月18日)於台北熱鬧登場。FIT鴻騰精密科技 (簡稱 FIT,港股交易代碼:6088)也不惶多讓,全力配合集團政策,以「電源管理、車聯網以及人機介面」三個面向切入連接器、系統零組件發展電動車產品,更陸續開花結果延伸出六大系列產品。

其中,最矚目的莫過於Smart Access 產品,FIT耕耘智慧鑰匙產品多年,FIT已搶先布局多達50多個專利,在Digital Key 3.0標準規範上,與重量級合作夥伴共同攜手打造Smart Access解決方案,並以軟硬體整合服務同時兼顧資訊安全與便捷的操作,除了提供傳統車廠高階車種產品外,未來更能應用在共享電動車的商業模式,FIT透過科技讓啟航產生更多元的可能性。完整方案將於11月8日MIH Demo Day在台北盛大展出。



發布時間: 2022年11月8日

稿

MIH Demo Day 必看! 鴻騰攜手 NXP 整合需時推出智慧車鑰匙方案

[台北-2022 年 11 月 8 日] 鴻海旗下鴻騰精密科技 (簡稱 FIT · 港股交易代碼:6088)攜手車用半 導體廠恩智浦(NXP Semiconductors)Smart Access 產品 · 透過科技讓啟航產生更多元的可能性,完整方案將於 11 月 8 日 MIH Demo Day 在台北盛大展出。

FIT 耕耘車用智慧鑰匙產品多年,目前已搶先布局多達 50 多個專利,在 Digital Key 3.0 標準規範上,與重量級合作夥伴 NXP 共同攜手打造 Smart Access 解決方案。對消費者而言,在保障車主資產安全的同時,也能透過智慧科技帶來更多便捷的操作。對車廠而言,FIT 將提供更加簡潔的硬體佈建與軟體整合服務。

鴻騰長期專注於精密電子元件製造,以「電源管理、車聯網以及人機介面」三個面向切入連接器、系統零組件發展電動車產品,更陸續開花結果延伸出六大系列產品,除了上述提及的 Smart Access 外,還包括了高速連接器解決方案(High Speed Interconnect)與高壓連接器解決方案 (High Voltage Interconnect)。現有車身充電插座產品為智能充電解決方案(Charging Port Solution),發揮 FIT 優秀的設計與製造工藝,以科技帶來安全性與實用性外,更兼顧美學、與車身融為一體。而車內無線充電解決方案則是結合 FIT 既有技術與乘車應用場票所打造的便捷產品。智慧天線(Integrated Antenna)則是發揮 FIT 長期資通訊產業的專長與產品設計的能力,提供車聯網的基礎設施。FIT 在布局 EV 產品多年、成果豐碩,未來將在車用領域持續為客戶帶來優異設計的解決方案!

September 2022

October 2022

November 2022

Q&A section

THANK YOU!





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Statement of Comprehensive Income

(M'USD)	3Q2022	3Q2021	YoY	2022 YTD	2021 YTD	YoY
Revenue	1,275	1,150	11%	3,376	3,132	8%
Gross Profit	207	168	23%	558	436	28%
Gross Profit Margin	16%	15%	11%	17%	14%	19%
Operating Profit	70	24	192%	158	20	690%
Profit before Tax	73	47	55%	180	61	195%
Income Tax Expense	(23)	(10)	130%	(45)	(16)	181%
Profit for the Year	50	37	35%	135	45	200%
Profit Attributed to :						
Owners of the Company	50	40	25%	135	49	176%
Non-controlling Interests	0	(3)	-100%	0	(4)	-100%
Basic EPS	0.71	0.59	19%	1.94	0.73	164%

Balance Sheet

(K'USD)	As of 30 Sep 2022	As of 30 Sep 2021	YoY
Cash and Cash equivalents	845,658	615,438	37%
Inventory	1,065,846	963,353	11%
Receivables	894,755	797,005	12%
Other current assets	194,025	250,215	-22%
Non-current assets	1,813,800	1,833,060	-1%
Total Assets	4,814,084	4,459,071	8%
Current Liabilities	1,854,715	2,132,184	-13%
Non-Current Liabilities	644,239	72,722	786%
Total Liabilities	2,498,954	2,204,906	13%
Equity	2,315,130	2,254,165	3%